



SciFi SiPMs irradiation study

Monitoring of the radiation damage induced aging of the LHCb SciFi tracker SiPMs during the first 9 months of Run 3.

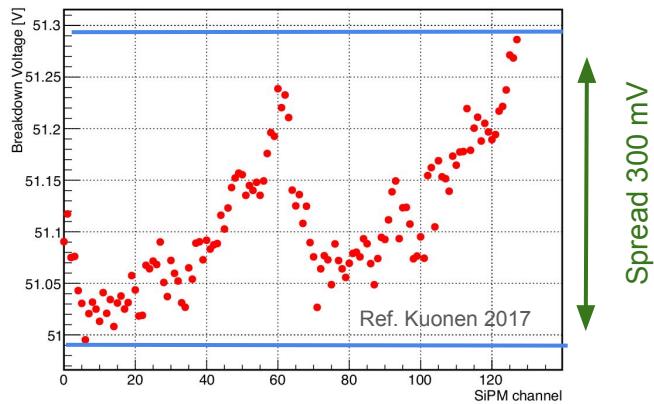
Federico Ronchetti, Elisabeth Maria Niel, Guido Haefeli

École Polytechnique Fédérale de Lausanne (EPFL)
Laboratoire de Physique des Hautes Énergies (LPHE)

Introduction: CAEN channels

- The SciFi HV power supply system is organised in **CAEN channels**
- Each CAEN channel provides the bias (V_{bias}) to **4 SiPM arrays** in a SciFi Mat
- V_{bias} is 3.5 V above the SiPM breakdown → **averaged $V_{bd}(T)$** over 4 SiPM arrays

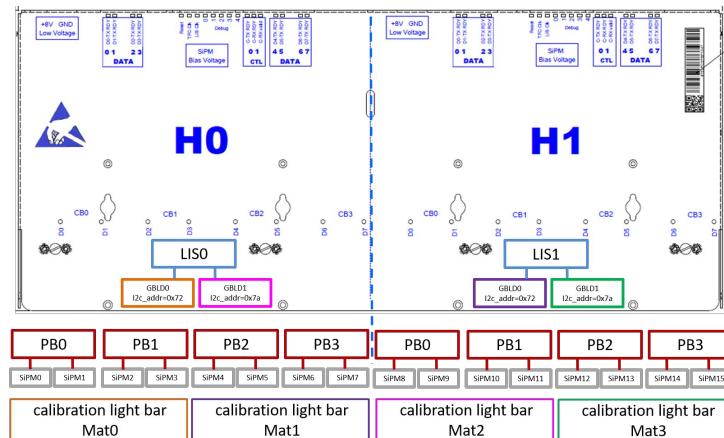
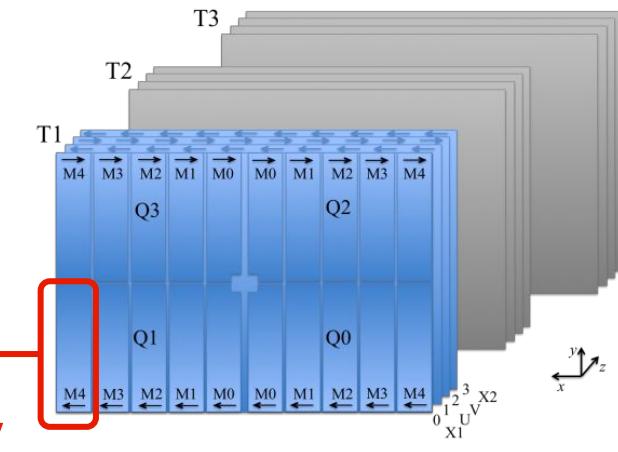
$$\Delta V = V_{bias} - V_{BD}(T)$$



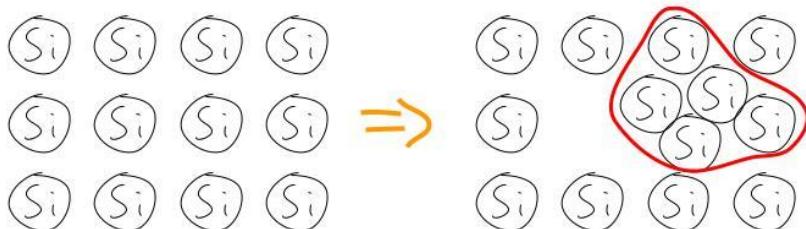
1 Module = 1 FE box

→ 4 Mats

1 CAEN channel = 1 MAt



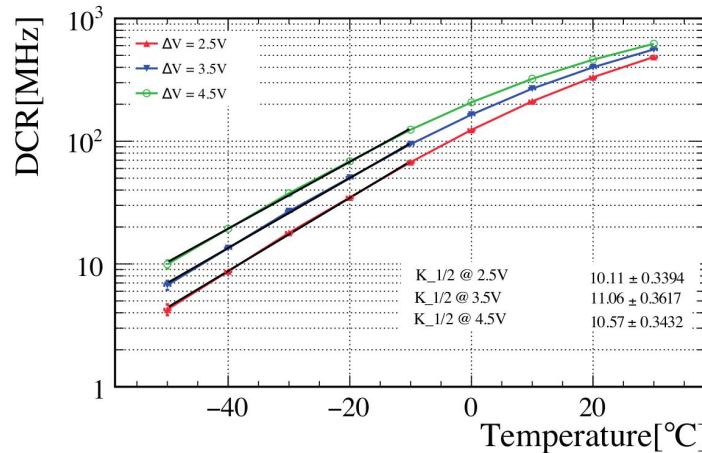
Introduction: radiation damages



- Radiation provokes **displacements of Si atoms** in the bulk → imperfections in the lattice
- **Increase of the DCR** in every channel

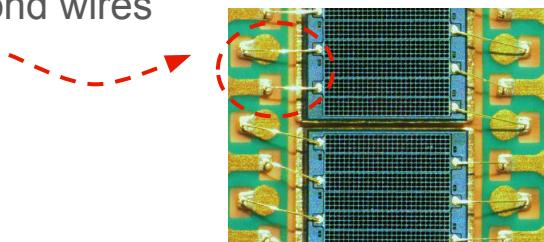
- Expected DCR for $6 \times 10^{11} n_{\text{eq}}/\text{cm}^2 \approx 14 \text{ MHz}$ @-40°C and $\Delta V=3.5V$
- Expected fluence from FLUKA $\approx 4.7 \times 10^{11} n_{\text{eq}}/\text{cm}^2$ at T3 after 50 fb^{-1}

$$f_R = 2^{\Delta T / K_{1/2}}$$

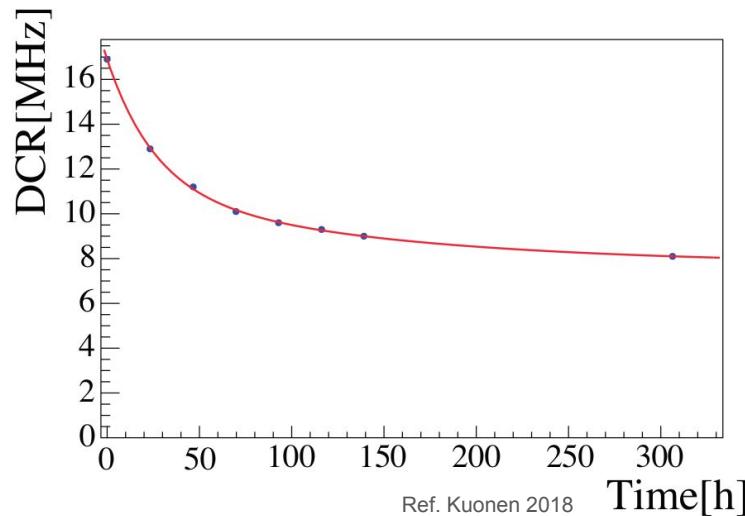
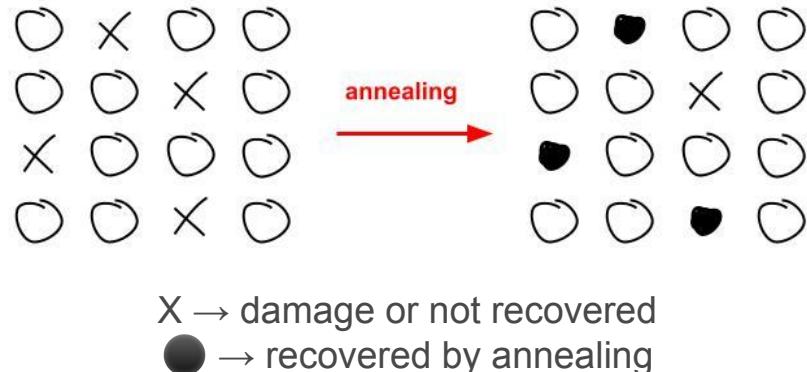


Introduction: annealing

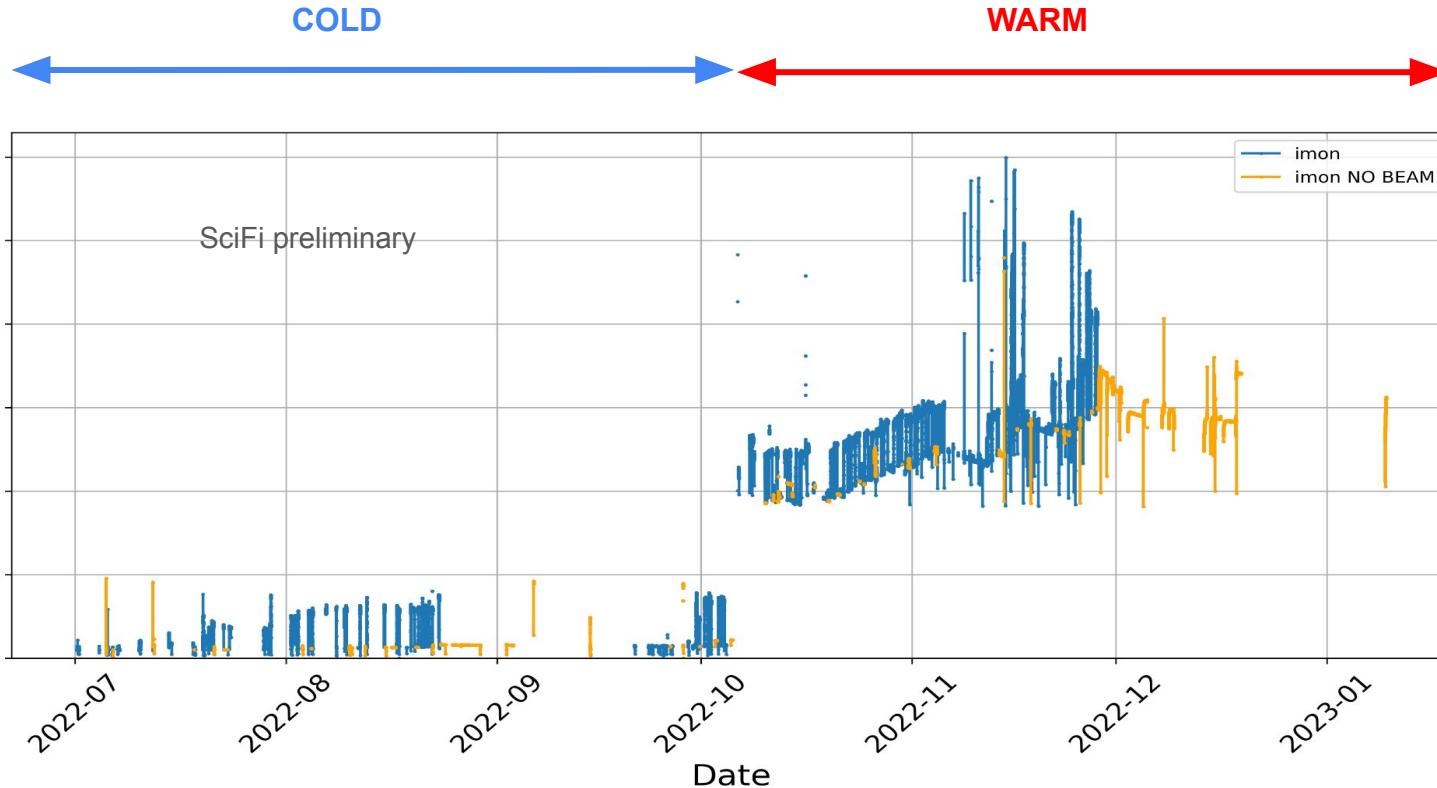
- Damages can be **recovered** by **heating up** the detector at room temperature or beyond
- Maximum temp. 35°C or deformation of the thin epoxy layer may damage the bond wires

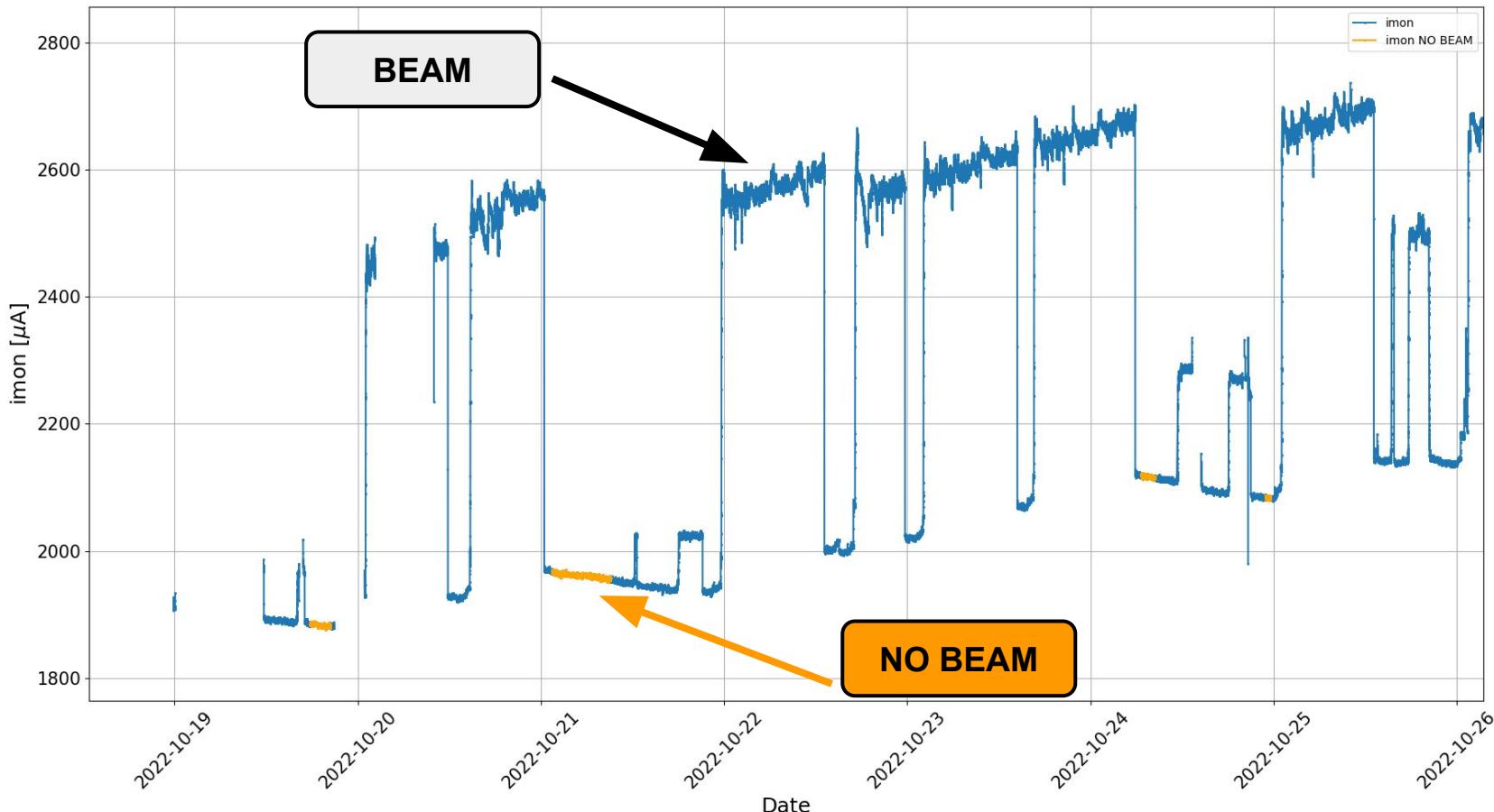


- The annealing plateaux depends on the temperature
- Complete annealing can be performed in **few weeks in YETS periods**

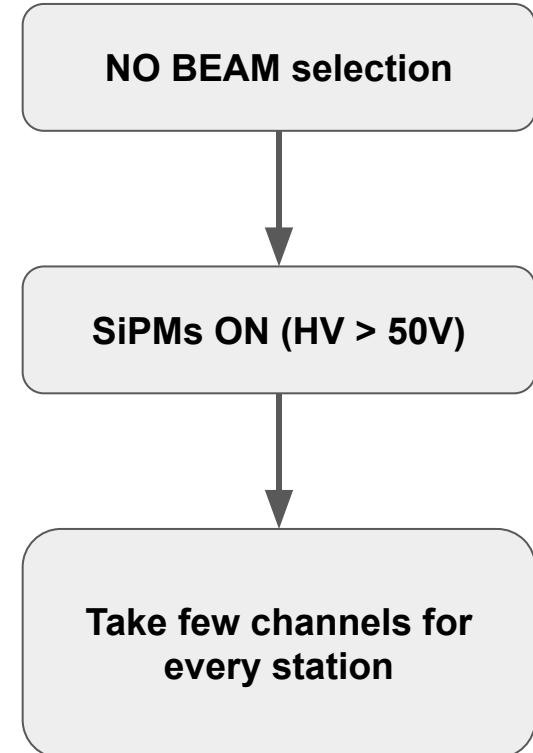
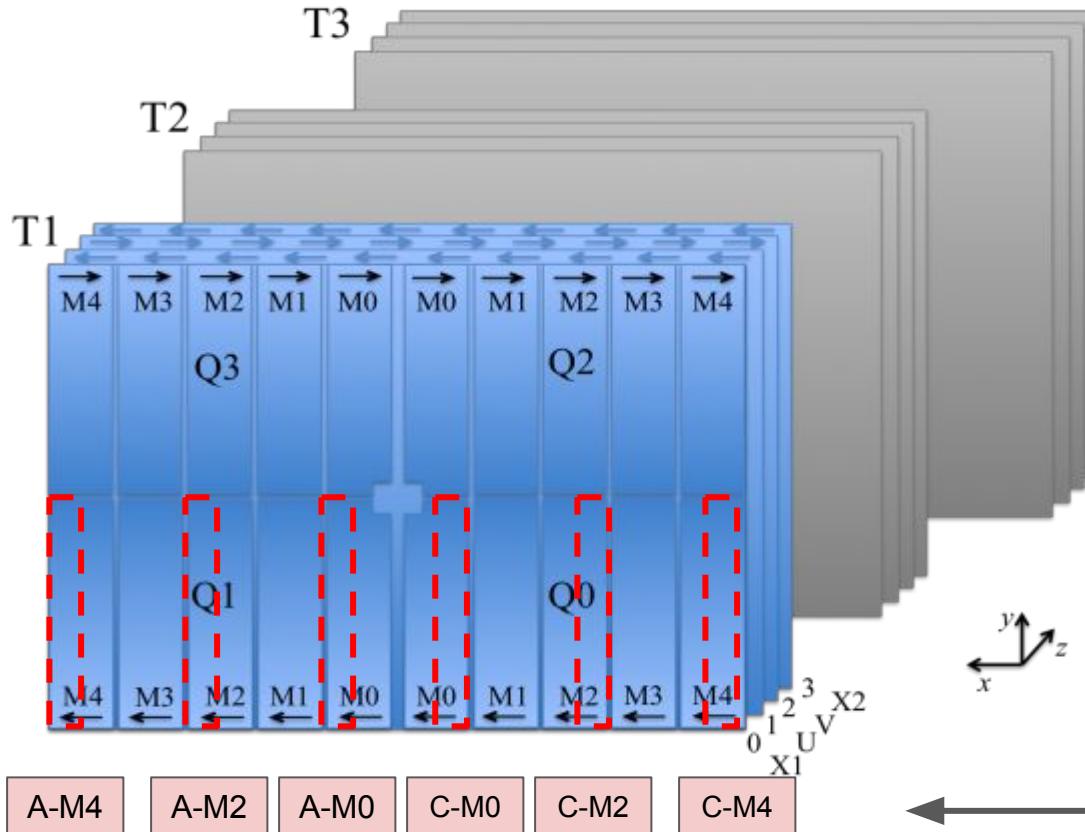


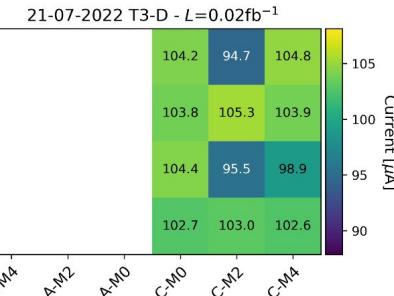
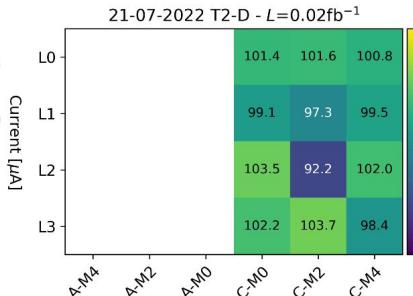
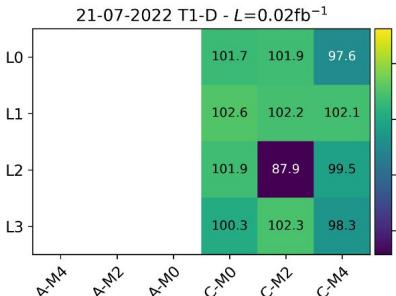
Snapshot of one Mat current July 2022 - January 2023



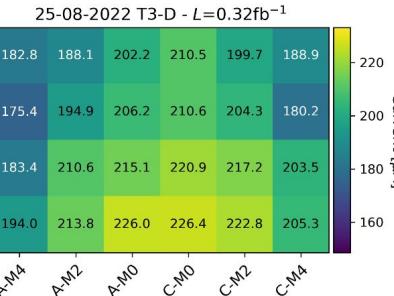
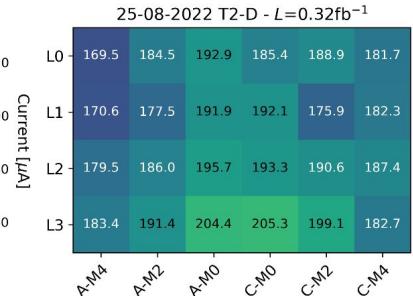
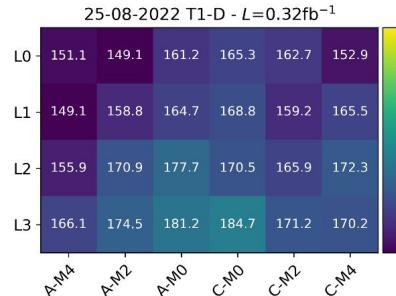


Method to extract dark current

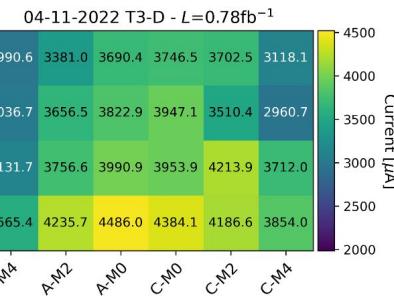
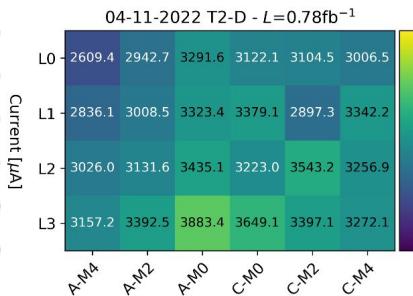
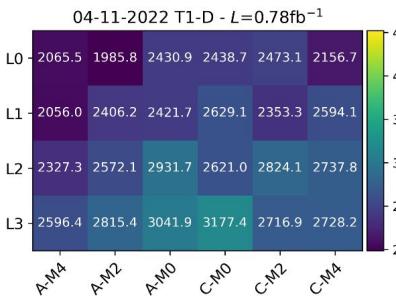




July - Cold
0.02 1/fb



August - Cold
0.32 1/fb

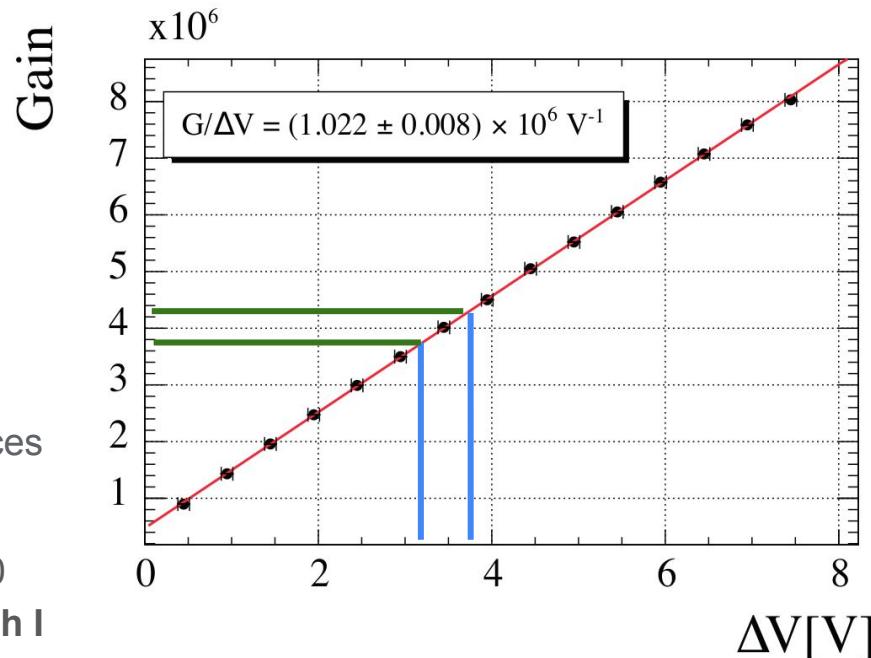


November - Warm
0.78 1/fb

Dark Count Rate (DCR)

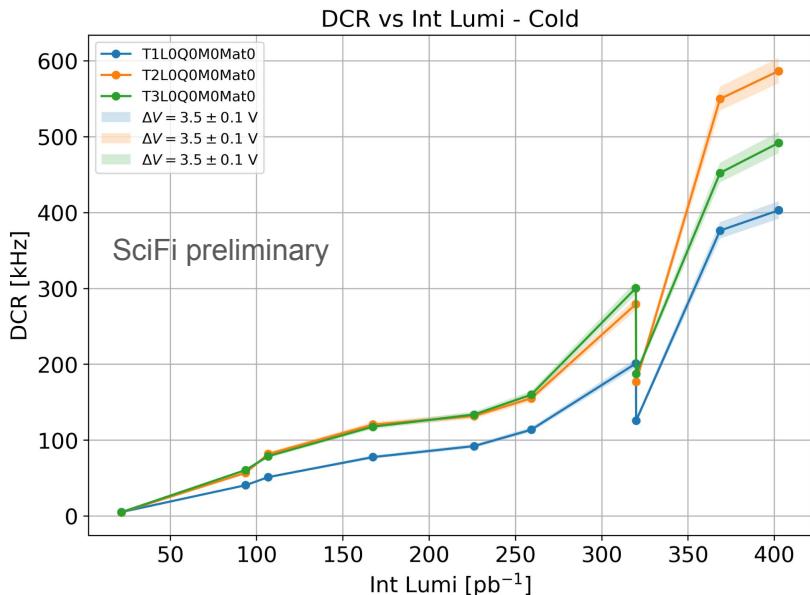
$$I = DCR \cdot G \cdot 512 \cdot e$$

- 512 = number of SiPM channels in one HV line (one Mat)
- I measured, **G** from gain measurement
- NOTE: G vs ΔV is a **steep curve** → small differences in ΔV = **big spread in G**
- **Long cables**: real applied voltage can differ by 100 mV from the nominal applied one (especially at **high I values**) due to voltage drop in the cables (compensated in the future)

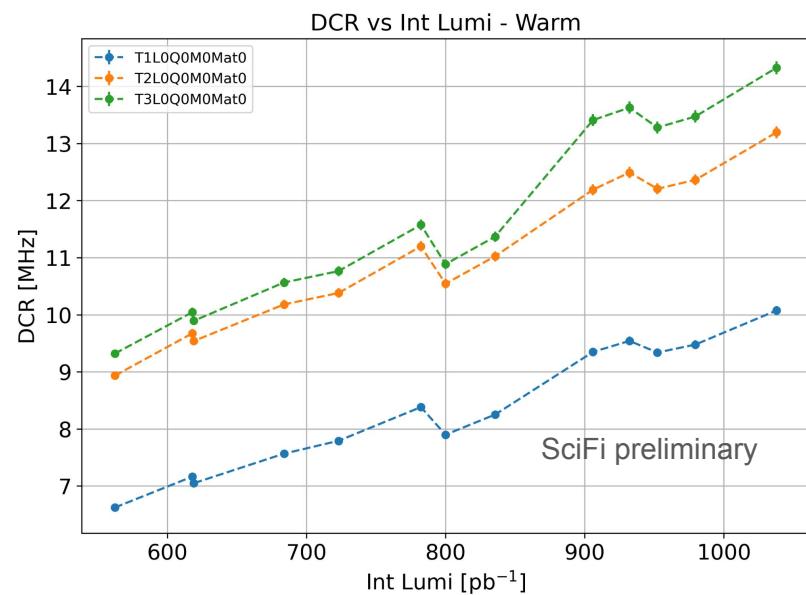


source: Kuonen

DCR COLD



DCR WARM

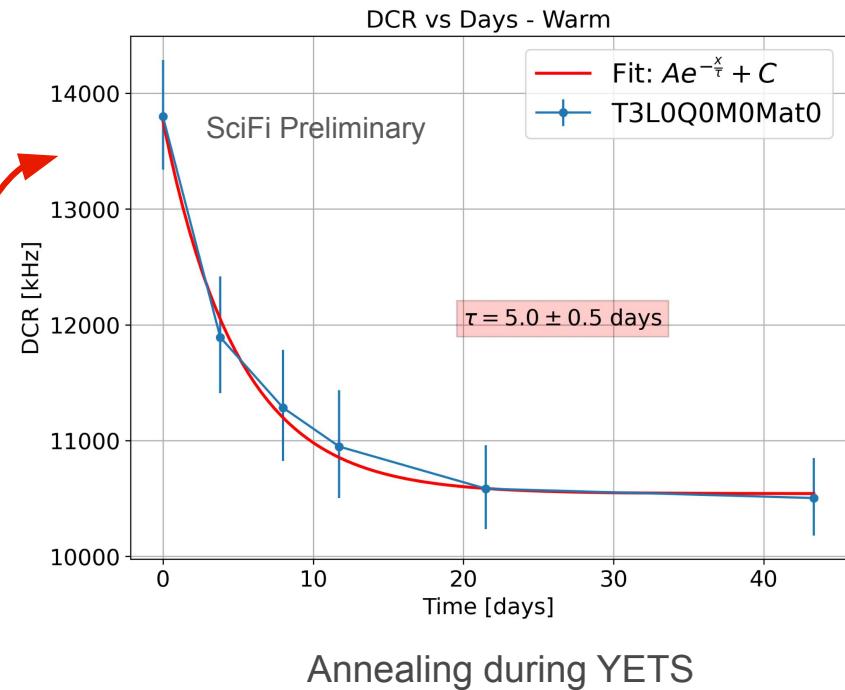
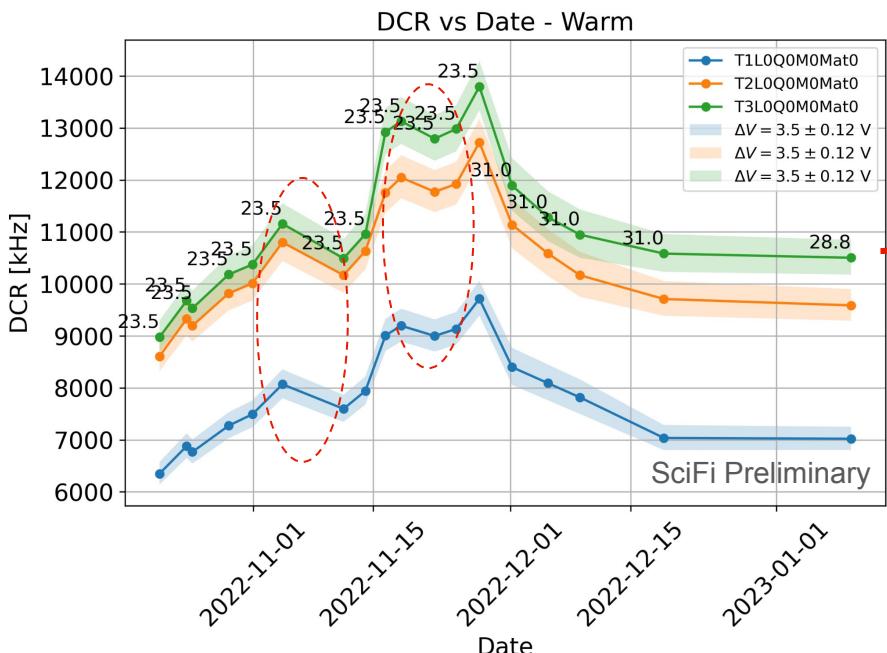


- Huge differences in temperature → difficulties to study the behaviour
- From 23 July 2022 to 5 October 2022

- Warm detector = end of life conditions → 14 MHz DCR x channel
- First effects of annealing seen during operations
- From 21 October 2022 to 9 January 2023

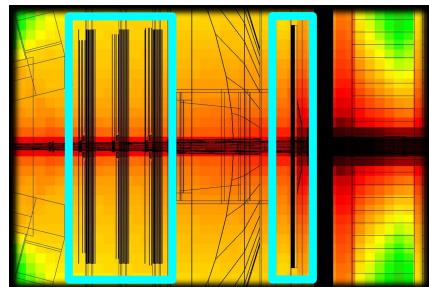
Annealing at room temperature

- Detector at $\sim 30^\circ\text{C}$ in december + not monitored temperatures during winter shutdown
- REMEMBER: the annealing started as soon as the detector was warmed up



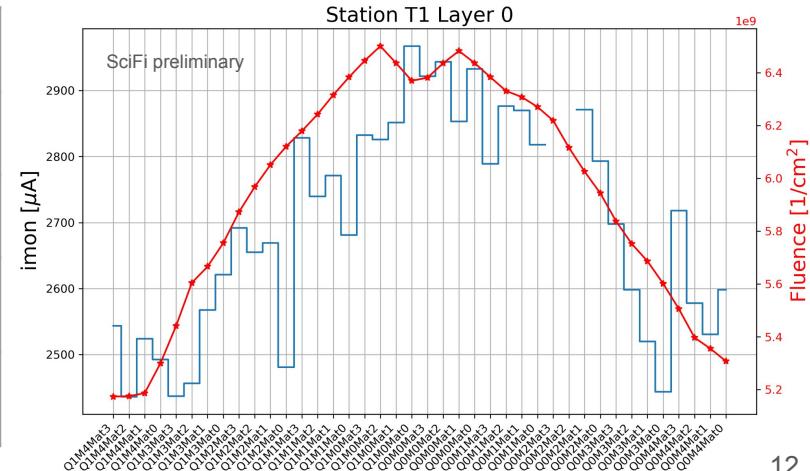
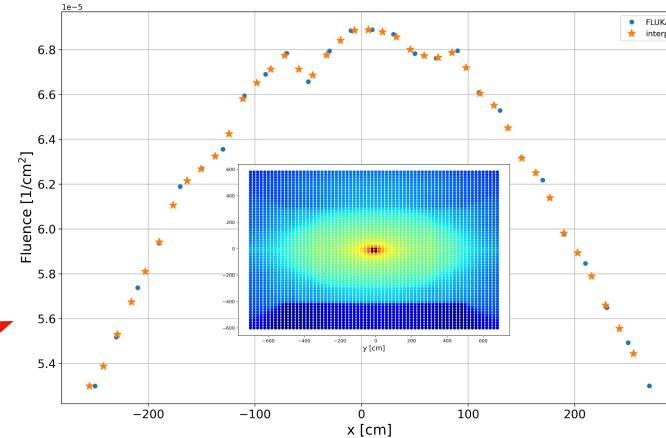
FLUKA simulation comparison

- FLUKA simulation datapoints by Matthias Karacson
- Each bin is $20 \times 20 \times 20 \text{ cm}^3$ in xyz extracted for 3 z positions
- Interpolation of points in the center of every Mat
- Scaling for 1.058 fb^{-1}



SciFi Shield

	T1/T3
FLUKA no shield	0.58
FLUKA w shield	0.74
SciFi (27/11/22)	0.70 ± 0.05
SciFi (22/02/23)	0.68 ± 0.04



Bias voltage calculation

- V_{bias} calculated by V_{bd} (known from R&D studies) and corrected for the temperature

$$V_{bias} = 3.5V + V_{bd} + 60mV (T - 25^{\circ}C) + V_{offset}$$

- V_{bias} is **highly T dependant** and so the response of the SiPMs
- REMEMBER: this is the applied V_{bias} at the CAEN module, the bias reaching the SiPM is lower due to the **voltage drop** along the cables

Temperature	SiPMs © H2015	Correction in Volts 0.059V*(T-25)
20		-0,295
10		-0,885
5		-1,18
0		-1,475
-10		-2,065
-20		-2,655
-30		-3,245
-39		-3,776
-40		-3,835
-45		-4,13
-50		-4,425

Line Drop Recovery

We need to compensate for the voltage drop from D3 to the SiPMs (120 m cables round-trip).

The distributions of HV lines is very complicated, return lines are shared in **groups of 11**.

CAEN module is compensating automatically
(new firmware)

Inputs: resistance of line and return

Rline = resistance of the outgoing cables

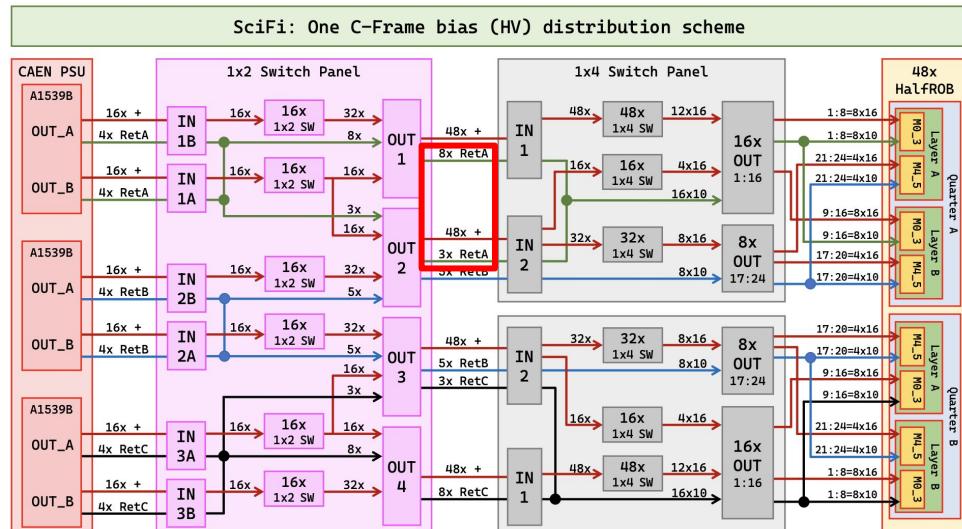
Rret = return line cables

We can only set the **Rline** and **Rreturn** every 16 channels assume have similar resistances.

Computed from cable characteristics:

147 Ohms/km at 20°C → SciFi 120 m

→Expected = 17 Ohm



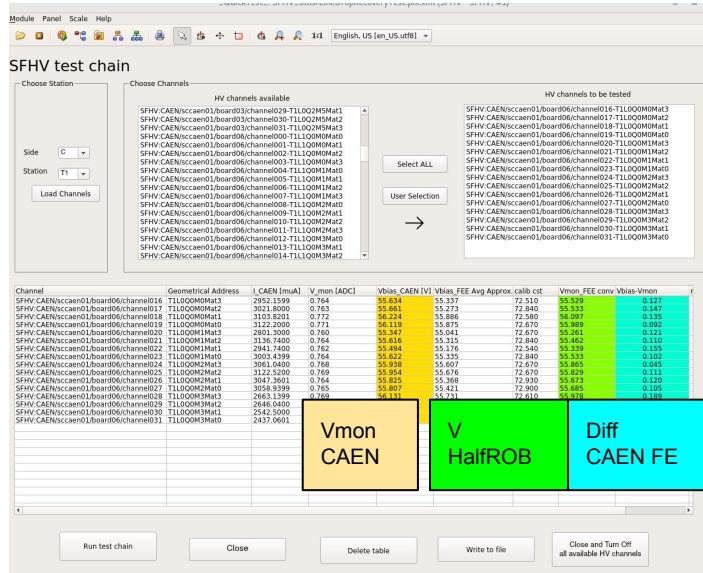
Scheme by
Ulisses C.



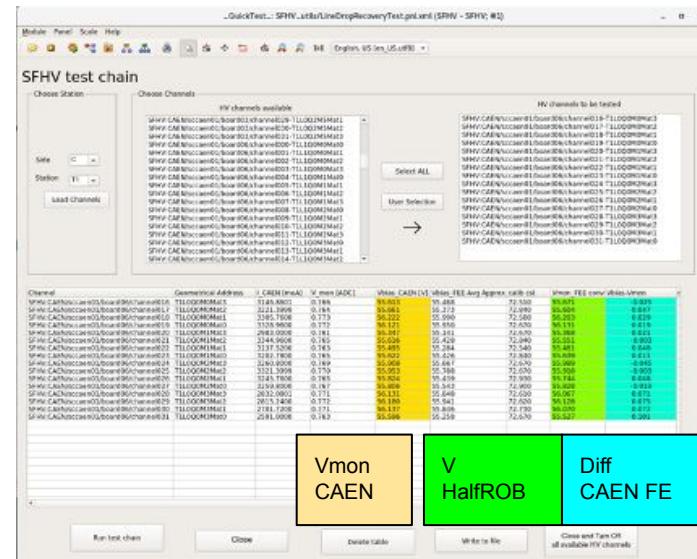
Line Drop Recovery

Implemented in WinCC control

Test using monitoring circuit in the FE after calibration



BEFORE LDR ~ 120 mV drop



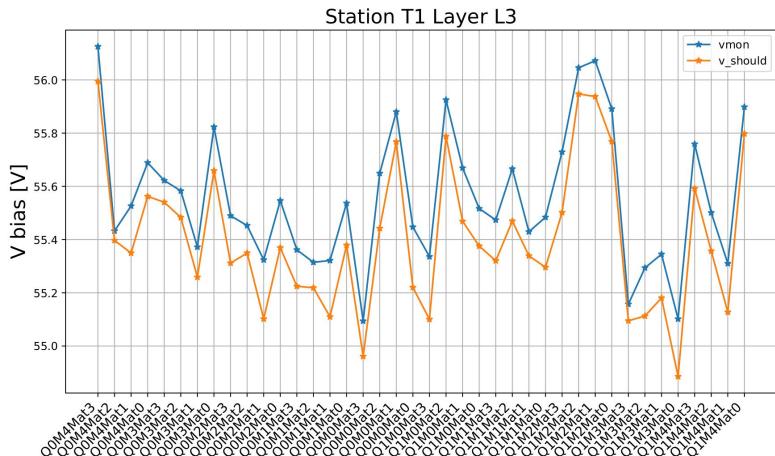
AFTER LDR ~ 5 mV drop

Return 1.8 Omega
Line 10 Omega

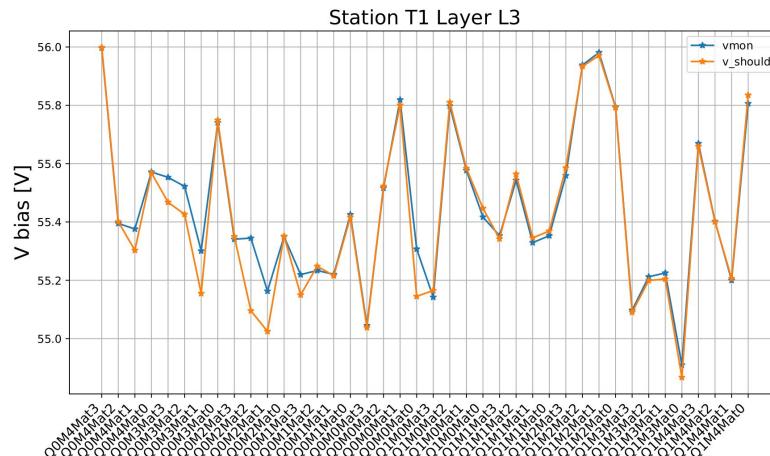
Importance of the right recipe

- Large differences in current between channels can be explained by a wrong recipe setting
- Take the averaged temperature and recompile the **Vbias** that should be applied **V_should**

- Good agreement with the recipe if created just before measurement and with LDR



BEFORE LDR and new recipe



AFTER LDR and new recipe

Conclusions and prospects

- The study of the **aging** of the SciFi SiPMs is ongoing:
 - **Currents and DCR monitored** in cold and warm periods
 - Observation of **annealing effect** during warm period
- The **recipe is time dependant** → a recipe generated on the base of the measured T a few days ago is probably not valid anymore → the choice of Vbias influenced the **gain** and consequently the DCR measurement of every channel
- **LDR compensation** implemented in the CAEN

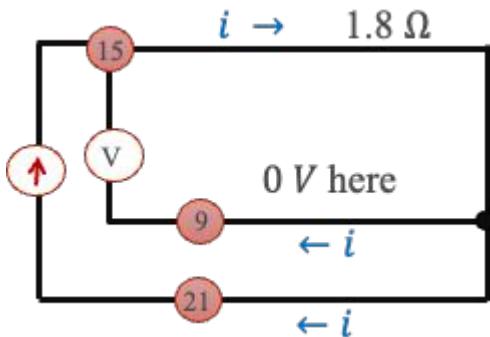
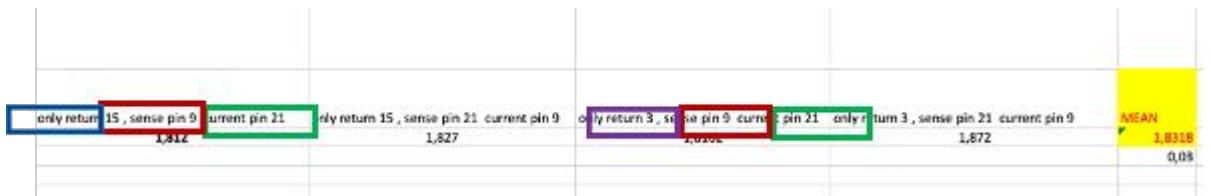
Prospects

- Study of **temperature spread** in one Mat to explain differences between channels
- Looking forward to **temperature scan**
- Implement the per **channel compensation** in the PACIFIC

Thanks for the attention

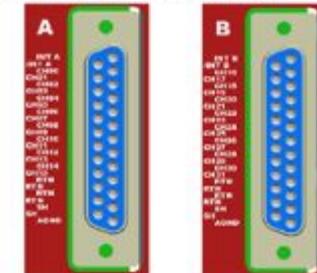
LDR measurement technical details

4 wires measurements on T1L3Q1M5



Return lines pins

DB25 connector pin assignment



INT - INT: interlock; RTN: channel return; AGND: ea

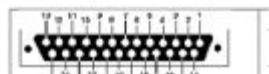


Fig. 2 – DB25 connector pin assignment (32 and 24 ch)

Offset from PACIFIC

- We are at digital value = 8
- Between 400 and 500 mV in Anode.
- No precise measurement oper PACIFIC available

